


Insulated Gate Bipolar Transistor (Trench IGBT), 80 A



SOT-227


FEATURES

- Trench IGBT technology
- Positive $V_{CE(on)}$ temperature coefficient
- Square RBSOA
- 10 μ s short circuit capability
- HEXFRED[®] low Q_{rr} , low switching energy
- T_J maximum = 150 °C
- Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996 
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

PRIMARY CHARACTERISTICS

V_{CES}	1200 V
I_C DC	80 A at 104 °C
$V_{CE(on)}$ typical at 80 A, 25 °C	2.0 V
Speed	8 kHz to 30 kHz
Package	SOT-227
Circuit configuration	Single switch with AP diode

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		1200	V
Continuous collector current	I_C	$T_C = 25$ °C	139	A
		$T_C = 90$ °C	93	
Pulsed collector current	I_{CM}		170	
Clamped inductive load current	I_{LM}		250	
Diode continuous forward current	I_F	$T_C = 25$ °C	98	
		$T_C = 90$ °C	61	
Single pulse forward current	I_{FSM}	10 ms sine or 6 ms rectangular pulse, $T_J = 25$ °C	350	
Gate to emitter voltage	V_{GE}		± 20	V
Power dissipation, IGBT	P_D	$T_C = 25$ °C	658	W
		$T_C = 90$ °C	316	
Power dissipation, diode	P_D	$T_C = 25$ °C	403	
		$T_C = 90$ °C	194	
Isolation voltage	V_{ISOL}	Any terminal to case, $t = 1$ min	2500	V



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{BR(CES)}	V _{GE} = 0 V, I _C = 2.6 mA	1200	-	-	V
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 80 A	-	2.0	2.55	
		V _{GE} = 15 V, I _C = 80 A, T _J = 125 °C	-	2.4	-	
		V _{GE} = 15 V, I _C = 80 A, T _J = 150 °C	-	2.5	-	
Gate threshold voltage	V _{GE(th)}	V _{CE} = V _{GE} , I _C = 2.6 mA	4.75	5.7	7.0	
Temperature coefficient of threshold voltage	ΔV _{GE(th)} /ΔT _J	V _{CE} = V _{GE} , I _C = 2.6 mA (25 °C to 125 °C)	-	-12	-	mV/°C
Collector to emitter leakage current	I _{CES}	V _{GE} = 0 V, V _{CE} = 1200 V	-	1.0	100	μA
		V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 125 °C	-	0.9	-	mA
Forward voltage drop	V _{FM}	I _F = 80 A, V _{GE} = 0 V	-	2.9	3.5	V
		I _F = 80 A, V _{GE} = 0 V, T _J = 125 °C	-	3.1	-	
		I _F = 80 A, V _{GE} = 0 V, T _J = 150 °C	-	3.1	-	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 220	nA

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Q _g	V _{GE} = -15 V, V _{GE} = ± 15 V	-	570	-		
Input capacitance	C _{ies}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz	-	4400	-	pF	
Reverse transfer capacitance	C _{res}		-	235	-		
Turn-on switching loss	E _{on}	I _C = 80 A, V _{CC} = 600 V, V _{GE} = 15 V, R _g = 1.0 Ω, L = 500 μH, T _J = 25 °C	-	3.0	-	mJ	
Turn-off switching loss	E _{off}		-	3.2	-		
Total switching loss	E _{tot}		-	6.2	-		
Turn-on switching loss	E _{on}	I _C = 80 A, V _{CC} = 600 V, V _{GE} = 15 V, R _g = 1.0 Ω, L = 500 μH, T _J = 125 °C	Energy losses include tail and diode recovery Diode used HFA16PB120	-	3.9	-	mJ
Turn-off switching loss	E _{off}			-	5.5	-	
Total switching loss	E _{tot}			-	9.4	-	
Turn-on delay time	t _{d(on)}			-	134	-	ns
Rise time	t _r			-	65	-	
Turn-off delay time	t _{d(off)}			-	281	-	
Fall time	t _f	-	155	-			
Reverse bias safe operating area	RBSOA	T _J = 150 °C, I _C = 250 A, R _g = 1.0 Ω, V _{GE} = 15 V to 0 V, V _{CC} = 800 V, V _P = 1200 V, L = 500 μH	Fullsquare				
Diode reverse recovery time	t _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _R = 400 V	-	179	-	ns	
Diode peak reverse current	I _{rr}		-	11.5	-	A	
Diode recovery charge	Q _{rr}		-	1029	-	nC	
Diode reverse recovery time	t _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _{rr} = 400 V, T _J = 125 °C	-	275	-	ns	
Diode peak reverse current	I _{rr}		-	17.8	-	A	
Diode recovery charge	Q _{rr}		-	2451	-	nC	
Short circuit safe operating area	SCSOA	V _{GE} = 15 V, V _{CC} = 800 V, V _{CE} max. = 1200 V, T _J = 150 °C	10			μs	

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T _J , T _{Stg}		-40	-	150	°C
Junction to case	IGBT	R _{thJC}	-	-	0.19	°C/W
	Diode		-	-	0.31	
Case to heatsink	R _{thCS}	Flat, greased surface	-	0.1	-	
Weight			-	30	-	g
Mounting torque		Torque to terminal	-	-	1.1 (9.7)	Nm (lbf. in)
		Torque to heatsink	-	-	1.3 (11.5)	Nm (lbf. in)
Case style		SOT-227				

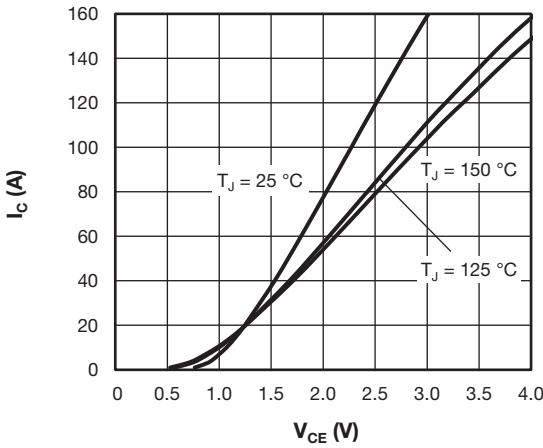


Fig. 1 - Typical IGBT Output Characteristics, $V_{GE} = 15\text{ V}$

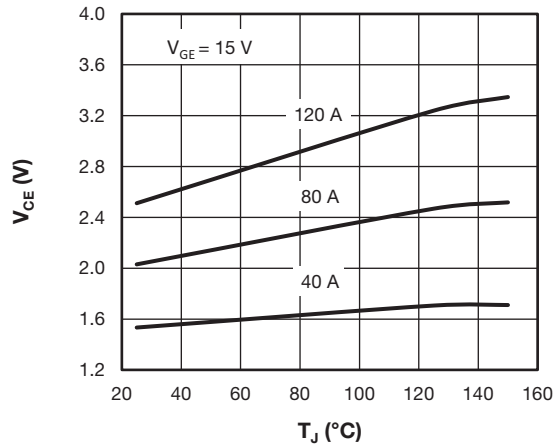


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

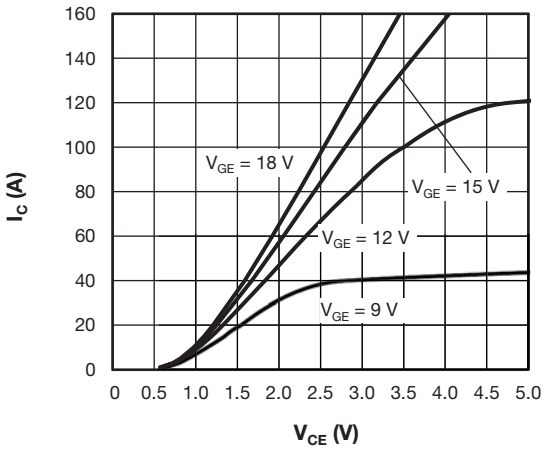


Fig. 2 - Typical IGBT Output Characteristics, $T_J = 125\text{ °C}$

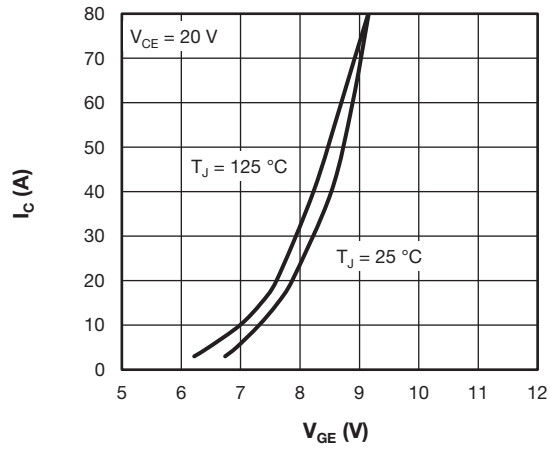


Fig. 5 - Typical IGBT Transfer Characteristics

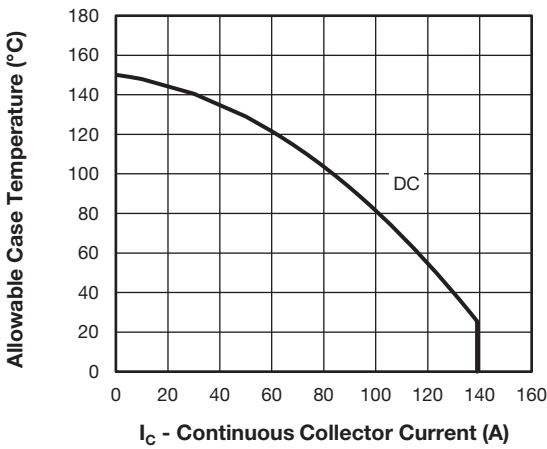


Fig. 3 - Maximum IGBT Continuous Collector Current vs. Case Temperature

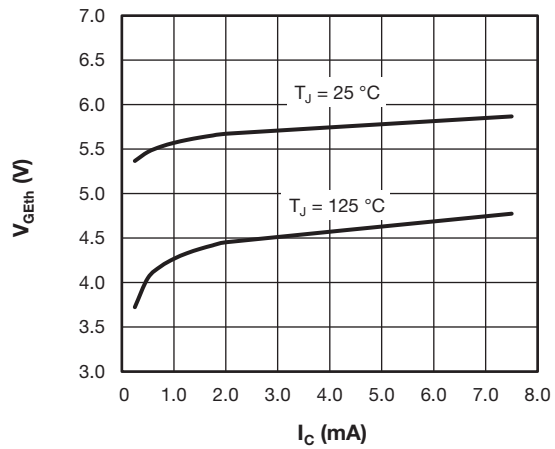


Fig. 6 - Typical IGBT Gate Threshold Voltage

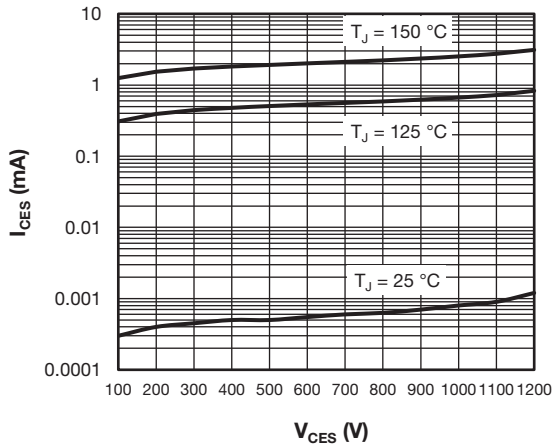


Fig. 7 - Typical IGBT Zero Gate Voltage Collector Current

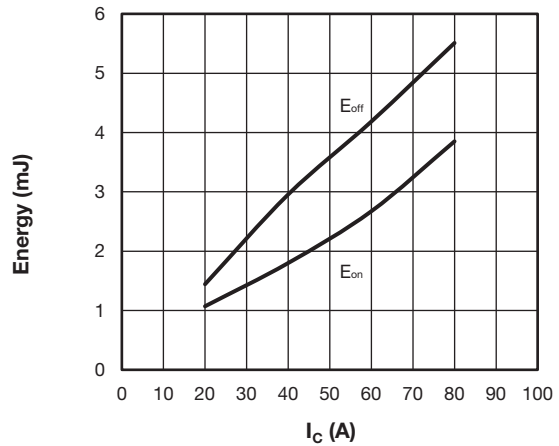


Fig. 10 - Typical IGBT Energy Loss vs I_C
 $T_J = 125\text{ }^\circ\text{C}$, $V_{CC} = 600\text{ V}$, $R_g = 1.0\ \Omega$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

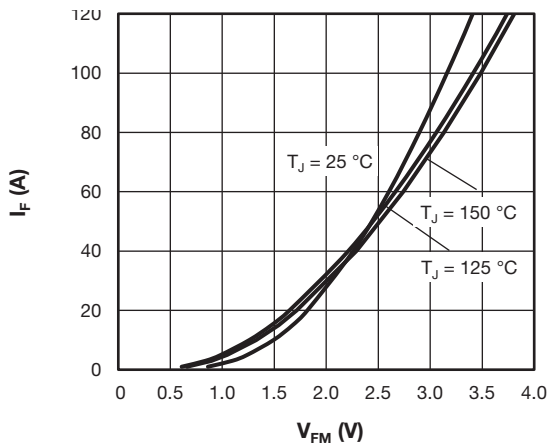


Fig. 8 - Typical Diode Forward Characteristics

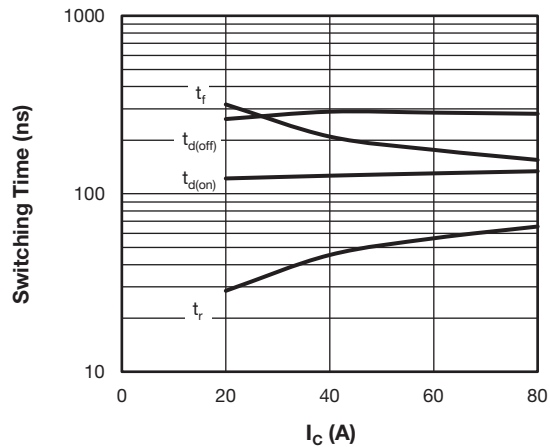


Fig. 11 - Typical IGBT Switching Time vs. I_C
 $T_J = 125\text{ }^\circ\text{C}$, $V_{CC} = 600\text{ V}$, $R_g = 1.0\ \Omega$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

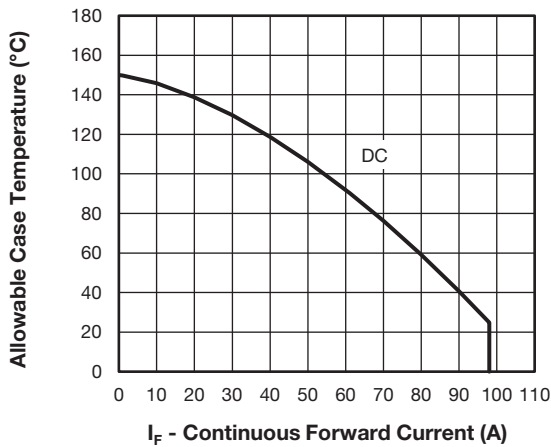


Fig. 9 - Maximum Diode Continuous Forward Current vs. Case Temperature

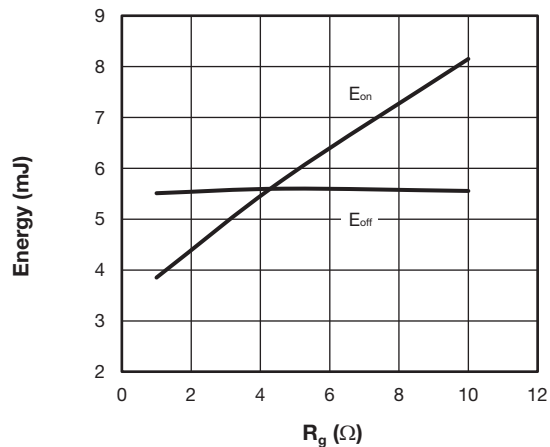


Fig. 12 - Typical IGBT Energy Loss vs. R_g
 $T_J = 125\text{ }^\circ\text{C}$, $V_{CC} = 600\text{ V}$, $I_C = 80\text{ A}$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

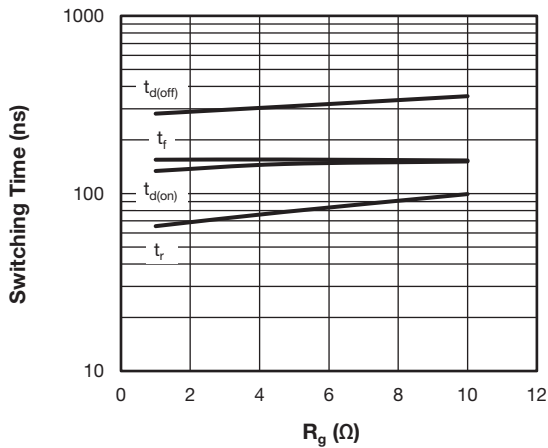


Fig. 13 - Typical IGBT Switching Time vs. R_g
 $T_J = 125^\circ\text{C}$, $V_{CC} = 600\text{ V}$, $I_C = 80\text{ A}$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

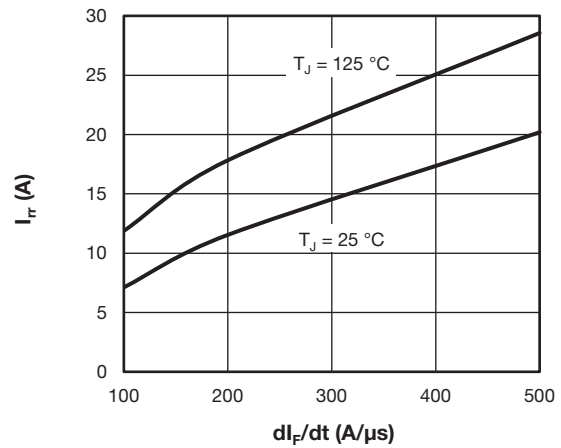


Fig. 15 - Typical Diode Reverse Recovery Current vs. di/dt
 $V_{rr} = 400\text{ V}$, $I_F = 50\text{ A}$

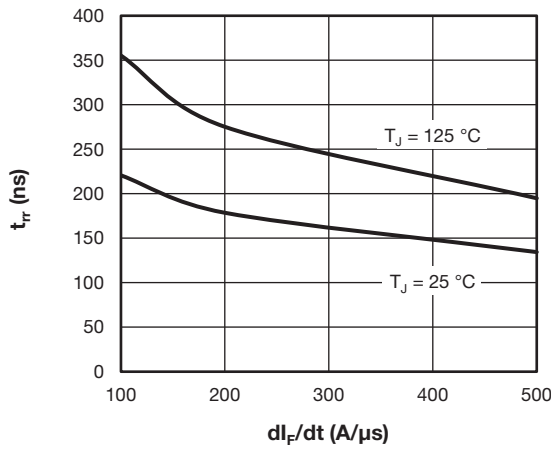


Fig. 14 - Typical Diode Reverse Recovery Time vs. di/dt
 $V_{rr} = 400\text{ V}$, $I_F = 50\text{ A}$

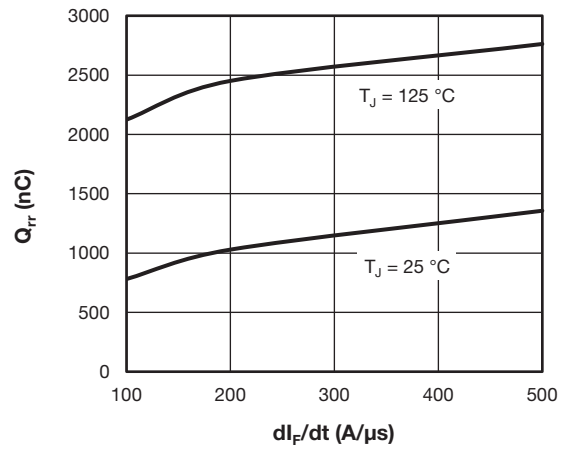


Fig. 16 - Typical Diode Reverse Recovery Charge vs. di/dt
 $V_{rr} = 400\text{ V}$, $I_F = 50\text{ A}$

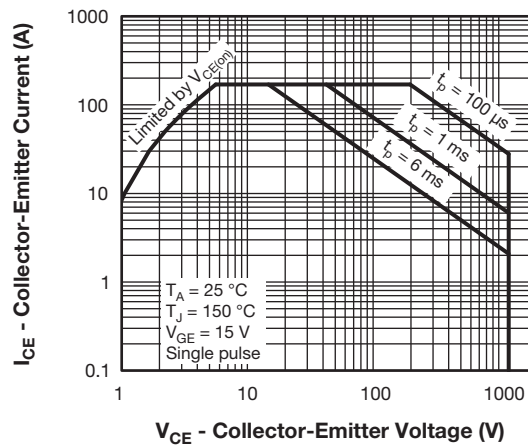


Fig. 17 - IGBT Safe Operating Area

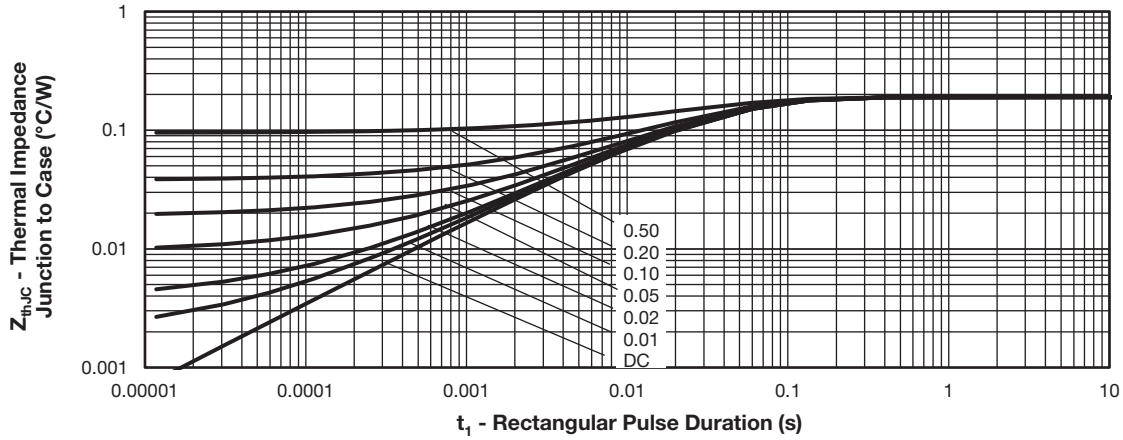


Fig. 18 - Maximum Thermal Impedance Z_{thJC} Characteristics (IGBT)

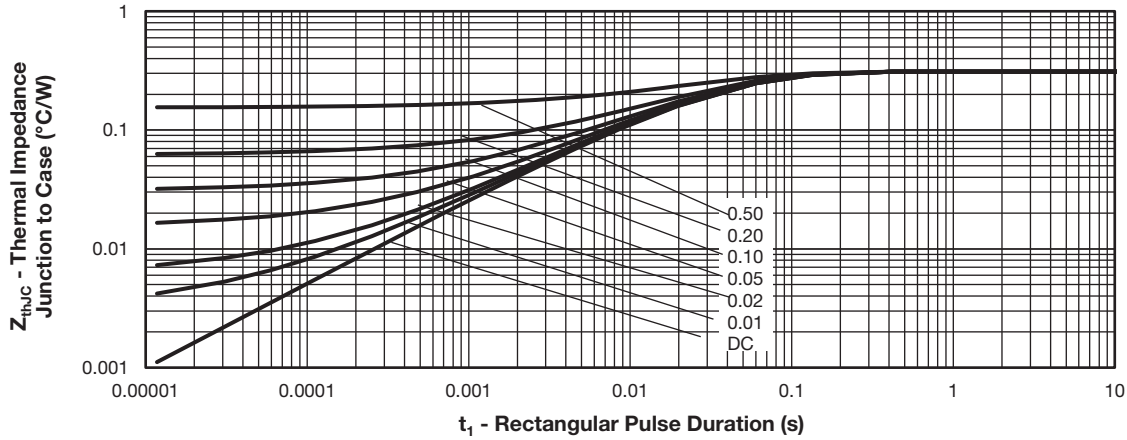


Fig. 19 - Maximum Thermal Impedance Z_{thJC} Characteristics (Diode)

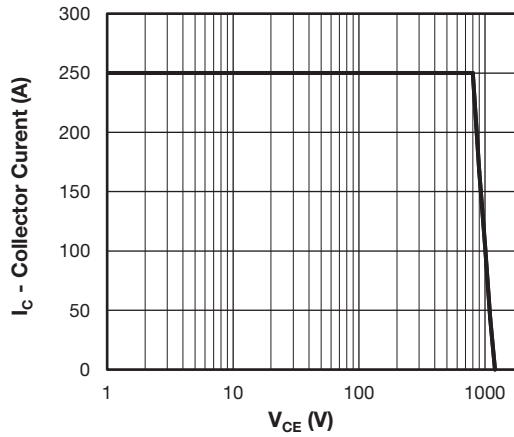
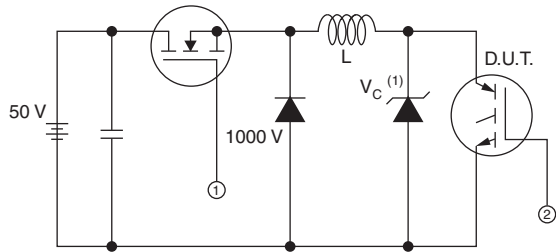


Fig. 20 - IGBT Reverse Bias SOA
 $V_{GE} = 15\text{ V}$, $T_J = 150\text{ °C}$



Note:

⁽¹⁾ Driver same type as D.U.T.; $V_C = 80\%$ of $V_{CE\ max}$.
Due to the 50 V power supply, pulse width, and inductor will increase to obtain I_D

Fig. 21 - Clamped Inductive Load Test Circuit

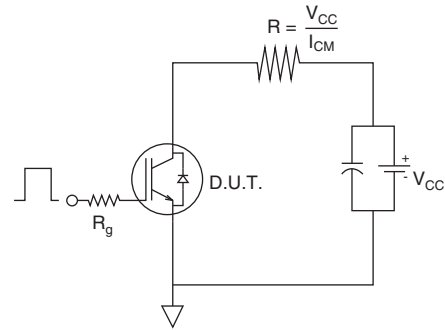


Fig. 22 - Pulsed Collector Current Test Circuit

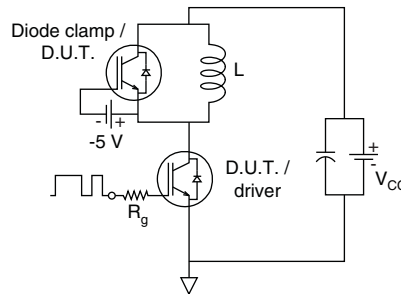


Fig. 23 - Switching Loss Test Circuit

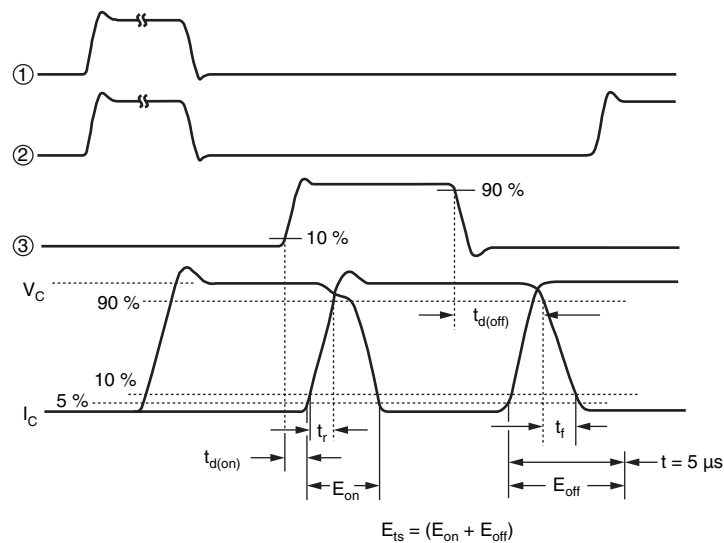


Fig. 24 - Switching Loss Waveforms Test Circuit

ORDERING INFORMATION TABLE

Device code	VS-	G	T	80	D	A	120	U
	①	②	③	④	⑤	⑥	⑦	⑧

- 1** - Vishay Semiconductors product
- 2** - Insulated gate bipolar transistor (IGBT)
- 3** - Trench IGBT technology
- 4** - Current rating (80 = 80 A)
- 5** - Circuit configuration (D = single switch with antiparallel diode)
- 6** - Package indicator (A = SOT-227)
- 7** - Voltage rating (120 = 1200 V)
- 8** - Speed / type (U = ultrafast)

CIRCUIT CONFIGURATION		
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
Single switch with AP diode	D	

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95423
Packaging information	www.vishay.com/doc?95425



SOT-227 Generation 2

DIMENSIONS in millimeters (inches)



Note

- Controlling dimension: millimeter



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